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What is claimed is:

- 1. A hardened voyage data recorder, comprising:
 - (a) a removable memory subsystem;
 - (b) a mounting base subsystem removably coupled to said memory subsystem; and
 - (c) electronic circuits for electronically accessing said memory subsystem, wherein said electronic circuits provide an ETHERNET access port for coupling said hardened voyage recorder to an ETHERNET network.
- A hardened voyage data recorder according to claim 1 wherein said electronic circuits include firmware which provides TCP/IP access over ETHERNET to said circuits.
- 3. A hardened voyage data recorder according to claim 2 wherein said firmware includes web pages for configuring said hardened voyage data recorder.
- 4. A hardened voyage data recorder according to claim 1 wherein said electronic circuits are located in said mounting base subsystem.

- 5. A hardened voyage data recorder according to claim 1 wherein said mounting base subsystem includes at least one watertight cable connector.
- 6. A hardened voyage data recorder according to claim 1 wherein said mounting base subsystem includes a first watertight cable connector for coupling with a power supply and a second cable connector for coupling with an ETHERNET network.
- A hardened voyage data recorder according to claim 1 wherein said electronic circuits accept both 110/220 VAC and 24 VDC power supplies.
- 8. A hardened voyage data recorder according to claim 1 20 further comprising a quick release V-clamp, wherein said removable memory subsystem has a lower flange, said mounting base subsystem has an upper flange, and said quick release V-clamp engages said upper flange and said lower flange whereby said memory subsystem and said base 25 subsystem are removably coupled to each other.

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- A hardened voyage data recorder according to claim 8 wherein said quick release V-clamp has two quick release levers.
 - 10. A hardened voyage data recorder according to claim 1 wherein said removable memory subsystem includes non-volatile memory enclosed within a boiler.
 - 11. A hardened voyage data recorder, comprising:
 - (a) a removable memory subsystem having a lower flange;
 - (b) a mounting base subsystem having an upper flange; and
 - (c) a quick release V-clamp engaging said upper flange and said lower flange whereby said memory subsystem and said base subsystem are removably coupled to each other.
 - 12. A hardened voyage data recorder according to claim 11 wherein said quick release V-clamp has two quick release levers.

- 13. A hardened voyage data recorder according to ${\tt claim}$
- 11 wherein said mounting base subsystem includes at least 5 one watertight cable connector.
 - 14. A hardened voyage data recorder according to claim11, wherein said mounting base subsystem includes a first watertight cable connector for coupling with a power
 - supply and a second cable connector for coupling with a data source.
- 15 15. A hardened voyage data recorder according to claim 11 wherein one of said upper flange and said lower flange has a groove adapted to receive an O-ring.
- 20 16. A hardened voyage data recorder according to claim 11 wherein said upper flange has two concentric grooves, each adapted to receive an O-ring.
- 25 17. A hardened voyage data recorder according to claim 16 further comprising one o-ring and one mesh gasket, one disposed in one of said two concentric grooves and the other disposed in the other of said two concentric grooves.

- 18. A hardened voyage data recorder, comprising:
- 5 (a) a removable memory subsystem; and
 - (b) a mounting base subsystem removably coupled to said memory subsystem, wherein said removable memory subsystem includes non-volatile memory enclosed within a boiler.
 - 19. A hardened voyage data recorder according to claim 18 wherein said mounting base subsystem includes at least one watertight cable connector.
- 20. A hardened voyage data recorder according to claim 18 wherein said mounting base subsystem includes a first 20 watertight cable connector for coupling with a power supply and a second cable connector for coupling with a data source.

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- 21. A hardened voyage data recorder according to claim
 18 further comprising a quick release V-clamp, wherein
 said removable memory subsystem has a lower flange, said
 mounting base subsystem has an upper flange, and said
 quick release V-clamp engages said upper flange and said
 lower flange whereby said memory subsystem and said base
 subsystem are removably coupled to each other.
- 22. A hardened voyage data recorder according to claim 21, wherein said quick release V-clamp has two quick release levers.
- 23. A hardened voyage data recorder according to claim
 21 wherein one of said upper flange and said lower flange has a groove adapted to receive an O-ring.
- 24. A hardened voyage data recorder according to claim 21 wherein said upper flange has two concentric grooves, each adapted to receive an O-ring.

- 25. A hardened voyage data recorder according to claim
 24 further comprising one o-ring and one mesh gasket, one disposed in one of said two concentric grooves and the
- 5 disposed in one of said two concentric grooves and the other disposed in the other of said two concentric grooves.
- 10 26. A hardened voyage data recorder, comprising:
 - (a) a removable memory subsystem;
 - (b) a mounting base subsystem removably coupled to said memory subsystem; and
 - (c) at least one memory interface converter chip coupled to said removable memory subsystem.

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27. A hardened voyage data recorder according to claim26 wherein said mounting base subsystem includes at least one watertight cable connector.

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data source.

- 28. A hardened voyage data recorder according to claim
 26 wherein said mounting base subsystem includes a first
 watertight cable connector for coupling with a power
 supply and a second cable connector for coupling with a
- 29. A hardened voyage data recorder according to claim 10 26 further comprising a quick release V-clamp, wherein said removable memory subsystem has a lower flange, said mounting base subsystem has an upper flange, and said quick release V-clamp engages said upper flange and said lower flange whereby said memory subsystem and said base 15 subsystem are removably coupled to each other.
 - 30. A hardened voyage data recorder according to claim 29 wherein said quick release V-clamp has two quick release levers.
 - 31. A hardened voyage data recorder according to claim 29 wherein one of said upper flange and said lower flange has a groove adapted to receive an O-ring.

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33. A hardened voyage data recorder according to claim 32 further comprising one o-ring and one mesh gasket, one disposed in one of said two concentric grooves and the other disposed in the other of said two concentric grooves.

- 34. A hardened voyage data recorder, comprising:
 - (a) a removable memory subsystem, wherein said removable memory subsystem includes a stacked memory and a plurality of memory interface chips arranged for communication with a processor such that a large number of memory chips may be driven; and
 - (b) a mounting base subsystem removably coupled to said memory subsystem.

35. A hardened voyage data recorder according to claim 34 wherein said mounting base subsystem includes at least one watertight cable connector.

- 36. A hardened voyage data recorder according to claim
 34 wherein said mounting base subsystem includes a first
- watertight cable connector for coupling with a power supply and a second cable connector for coupling with a data source.
- 37. A hardened voyage data recorder according to claim 34 further comprising a quick release V-clamp, wherein said removable memory subsystem has a lower flange, said mounting base subsystem has an upper flange, and said quick release V-clamp engages said upper flange and said lower flange whereby said memory subsystem and said base subsystem are removably coupled to each other.
- 38. A hardened voyage data recorder according to claim 20 37 wherein said quick release V-clamp has two quick release levers.
- 39. A hardened voyage data recorder according to claim
 25 37 wherein one of said upper flange and said lower flange has a groove adapted to receive an O-ring.

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- 40. A hardened voyage data recorder according to claim37 wherein said upper flange has two concentric grooves,5 each adapted to receive an O-ring.
 - 41. A hardened voyage data recorder according to claim
 40 further comprising one o-ring and one mesh gasket, one
 disposed in one of said two concentric grooves and the
 other disposed in the other of said two concentric
 grooves.
 - 42. A process for fabricating a hardened voyage data recorder, comprising the steps of:
 - (a) utilizing a removable memory subsystem;
 - (b) removably coupling said memory subsystem to a mounting base subsystem; and
 - (c) accessing said memory subsystem electronically utilizing electronic circuits, wherein said electronic circuits provide an ETHERNET access port for coupling said hardened voyage recorder to an ETHERNET network.

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- 43. A process for fabricating a hardened voyage data recorder, comprising the steps of:
- (a) utilizing a removable memory subsystem having a lower flange;
 - (b) utilizing a mounting base subsystem having an upper flange; and
 - (c) removably coupling said memory subsystem and said base subsystem to each other utilizing a quick release V-clamp engaging said upper flange and said lower flange.
 - 44. A process for fabricating a hardened voyage data recorder, comprising the steps of:
 - (a) utilizing a removable memory subsystem; and
 - (b) removably coupling a mounting base subsystem to said memory subsystem, wherein said removable memory subsystem includes non-volatile memory enclosed within a boiler.

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- 45. A process for fabricating a hardened voyage data recorder, comprising the steps of:
- 5 (a) utilizing a removable memory subsystem;
 - (b) removably coupling a mounting base subsystem to said memory subsystem; and
 - (c) coupling at least one memory interface converter chip to said removable memory subsystem.
 - 46. A process for fabricating a hardened voyage data recorder, comprising the steps of:
- 20 (a) utilizing a memory subsystem including a stacked memory and a plurality of memory interface chips arranged for communication with a processor such that a large number of memory chips may be driven; and
 - (b) removably coupling a mounting base subsystem to said memory subsystem.